

In the claims:

Please amend the claims as follows:

1. (Currently Amended) A back cover for a lamp body that includes a cord insertion hole for inserting a power supply cord for supplying current to a light source bulb, and a cylindrical outer wall surrounding the cord insertion hole constructed to enable the power supply cord to be fixed and integrated by a resin mold within the outer wall, comprising:

~~a resin mold portion formed from a lower first resin mold layer having a first surface on the cord insertion hole side, said first layer adhered that adheres well to the back cover and having a second surface opposite to the first surface; and~~

~~an upper a second resin mold layer laminated over to the second surface of the first lower mold layer which has good heat resistance characteristics.~~

2. (Currently Amended) A back cover for a lamp body according to claim 1, wherein the back cover is made of polypropylene, the ~~lower first resin mold layer~~ is made of at least one of an olefin based and a synthetic resin based synthetic rubber hot melt agent, and the ~~upper second resin mold layer~~ is made of a polyamide based hot melt agent.

3. (Currently Amended) A back cover for a lamp body according to claims 1 or 2, wherein a ratio of thickness between the ~~lower first mold resin layer~~ and the ~~upper second mold resin layer~~ is ~~set to~~ two to one.

4. (Original) A back cover for a lamp body according to claim 1, wherein the power supply cord is coated with a polyethylene based resin.

5. (Currently Amended) A method for forming a waterproof seal about a power supply cord in a back cover of a lamp body comprising:

inserting the power supply cord through a cord insertion hole;

~~filling forming a first resin mold layer in a cylindrical outer wall that surrounds the cord insertion hole with a predetermined amount of soft synthetic resin; and~~

~~pouring an upper laminating a second resin mold layer over on the resin to laminate the resin first resin mold layer.~~

6. (New) An apparatus, comprising:

a cover that includes a hole and a wall to form a well surrounding the hole;
a cord passed through the hole;
a first resin mold layer formed within the well and surrounding the cord to cover the hole, said first layer having a first surface adhered to the cover and having a second surface opposite to the first surface; and
a second resin mold layer laminated to the second surface of the first mold layer.

7. (New) The apparatus of claim 6, wherein the cover is made of polypropylene, the first resin mold layer is made of at least one of an olefin based and a synthetic resin based synthetic rubber hot melt agent, and the second resin mold layer is made of a polyamide based hot melt agent.

8. (New) The apparatus of claim 6, wherein the a ratio of thickness between the first mold resin layer and the second mold resin layer is two to one.

9. (New) The apparatus of claim 7, wherein the a ratio of thickness between the first mold resin layer and the second mold resin layer is two to one.